

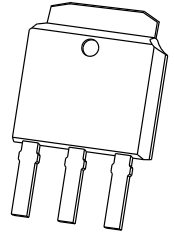
**TO-251S Plastic-Encapsulate MOSFETS****CJD04N65**

N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
650V	2.3Ω@10V	4A

GENERAL DESCRIPTION

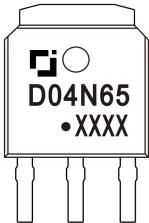
This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

TO-251S

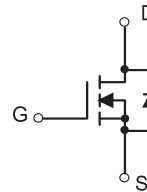
1. GATE
2. DRAIN
3. SOURCE

FEATURE

- High Current Rating
- Lower $R_{DS(on)}$
- Lower Capacitance
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified

MARKING

D04N65 = Device code
Solid dot = Green molding compound device,
if none, the normal device
XXXX=Code

EQUIVALENT CIRCUIT**Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	±30	
Continuous Drain Current	I_D	4.0	A
Pulsed Drain Current	I_{DM}	16	
Single Pulsed Avalanche Energy (note1)	E_{AS}	280	mJ
Power Dissipation	P_D	1.25	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	100	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 ~+150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes , 1/8"from case for 5 seconds	T_L	260	

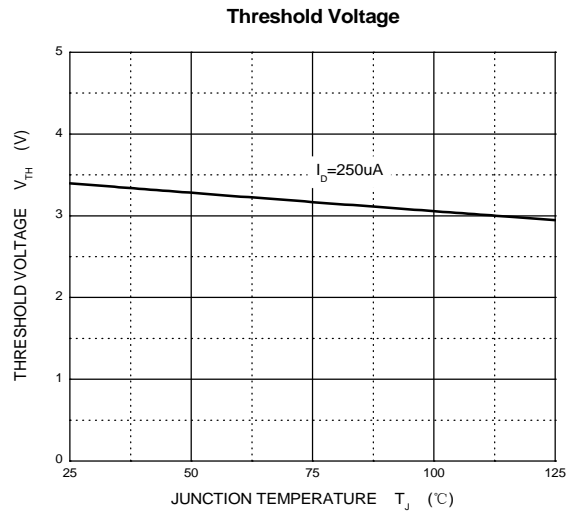
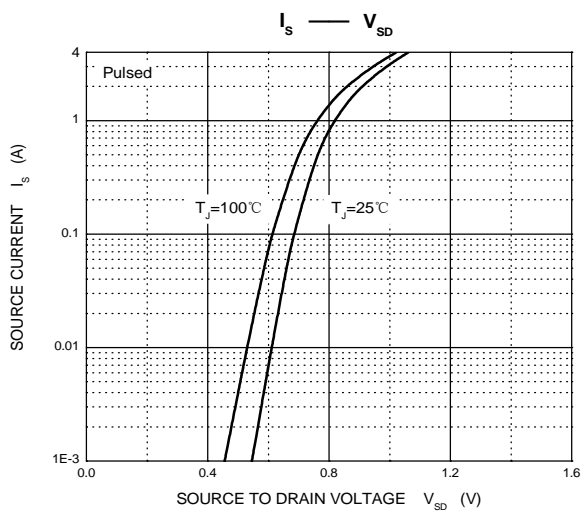
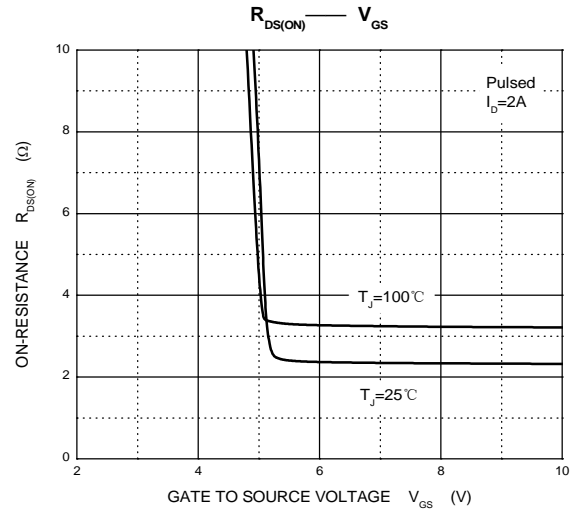
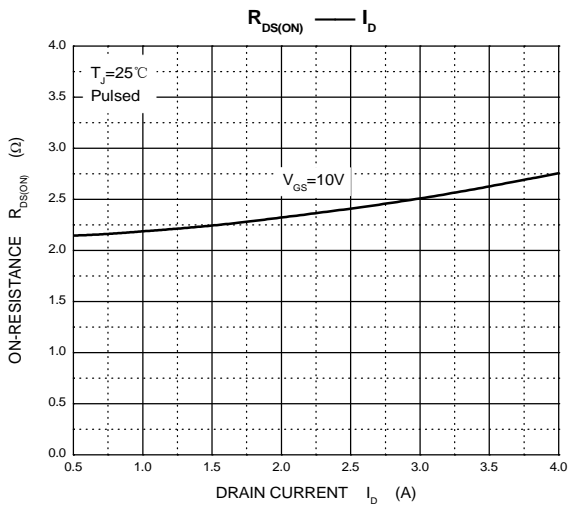
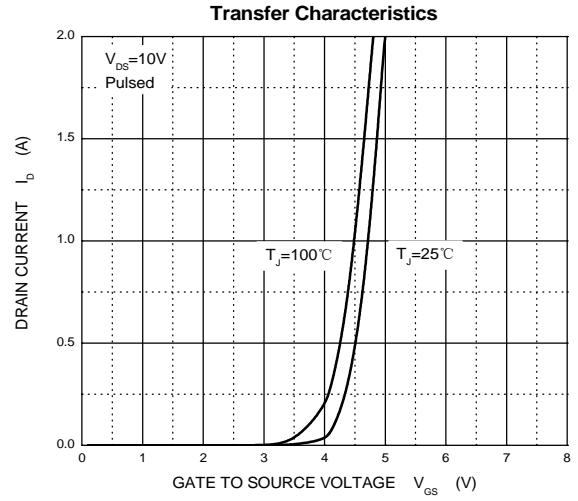
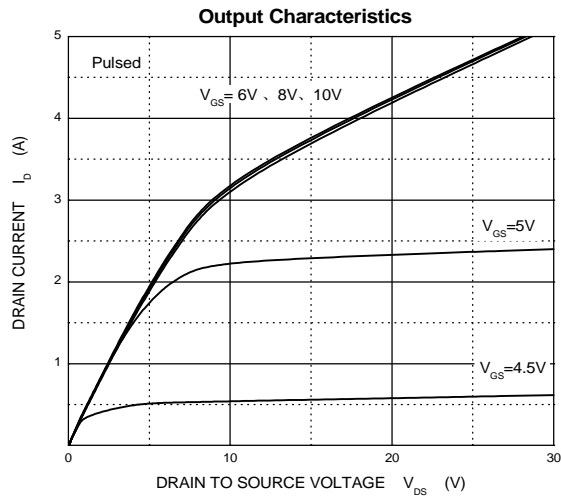
Electrical characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	650			V
Drain-source diode forward voltage(note2)	V _{SD}	V _{GS} = 0V, I _S =4.0A			1.5	
Zero gate voltage drain current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			25	μA
Gate-body leakage curren (note2)	I _{GSS}	V _{DS} =0V, V _{GS} = ±30V			±100	nA
On characteristics (note2)						
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.0	3.5	4.0	V
Static drain-source on-resistance	R _{Ds(on)}	V _{GS} =10V, I _D =2.0A		2.3	3.0	Ω
Dynamic characteristics (note 3)						
Input capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f =1MHz			760	pF
Output capacitance	C _{oss}				180	
Reverse transfer capacitance	C _{rss}				20	
Switching characteristics (note 3)						
Total gate charge	Q _g	V _{DS} =480V, V _{GS} =10V, I _D =4.0A		5.0	10	nC
Gate-source charge	Q _{gs}			2.7		
Gate-drain charge	Q _{gd}			2.0		
Turn-on delay time (note3)	t _{d(on)}	V _{DD} =300V, V _{GS} =10V, R _G =9.1Ω, I _D =4.0A			20	ns
Turn-on rise time (note3)	t _r				10	
Turn-off delay time (note3)	t _{d(off)}				40	
Turn-off fall time (note3)	t _f				20	

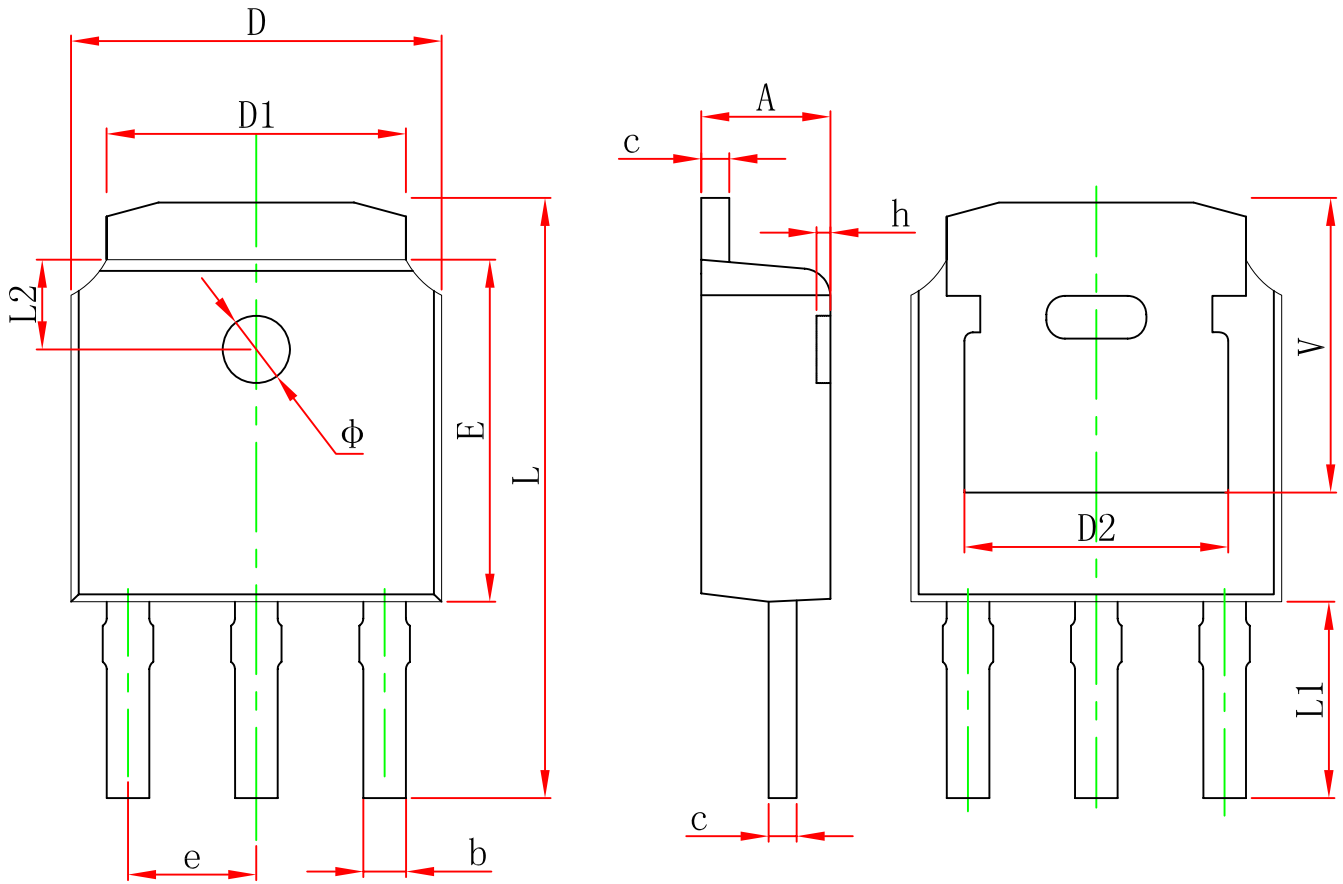
Notes :

1. L=30mH, I_L=4 A, V_{DD}=100V, R_G=25Ω, Starting T_J=25°C.
2. Pulse Test : Pulse width≤300μs, duty cycle ≤2%.
3. These parameters have no way to verify.

Typical Characteristics



TO-251S Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	10.312	10.912	0.406	0.430
L1	3.300	3.700	0.130	0.146
L2	1.600 REF.		0.063 REF.	
ϕ	1.100	1.300	0.043	0.051
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	